



Material Content Data Sheet

Umbrella Spec	EconoPACK™ + ; B-series						
Date	2012-08-28			RoHS compliant		Yes	
Revision	4.0						
Construction element	Material group	Materials	CAS-Nr. if applicable	Average mass [%]*	Sum [%]	Traces	Comment
chip	inorganic material	silicon	7440-21-3	0,2	0,2		
Base plate and substrate including metallisation	non noble metal	copper	7440-50-8	63,2	65,7		
	inorganic material	aluminium oxid	1344-28-1	1,2			
	non noble metal	tin	7440-31-5	1,0			
	noble metal	silver	7440-22-4	0,3			
	non noble metal	nickel	7440-02-0			X	
	non noble metal	magnesium	7439-95-4			X	
wire	non noble metal	aluminium	7429-90-5			X	
encapsulation	polymers	silicone gel		11,1	11,1		
housing	polymers	PBT		8,1	14,1		
	inorganic material	antimonytrioxide	1309-64-4	0,8			
	plastics	brominated resin		0,6			
	plastics	chlorinated resin		0,4			
lead, finish and plating	inorganic material	silicondioxide / glasfiber		4,2			
	non noble metal	copper	7440-50-8	5,6	8,9		
	ferrous metal	steel		3,3			
	non noble metal	cobalt	7440-48-4			X	
	non noble metal	zinc	7440-66-6			X	
	non noble metal	tin	7440-31-5			X	
	noble metal	silver	7440-22-4			X	
	non noble metal	nickel	7440-02-0			X	
	non noble metal	aluminium	7429-90-5			X	
	smd (including thermistors, resistors and shunts)	inorganic material	lead oxide	1317-36-8	0,01	0,01	
non noble metal		copper	7440-50-8			X	
non noble metal		tin	7440-31-5			X	
noble metal		silver	7440-22-4			X	
deviation	<25%			Sum in total		100,0	

Weight range of product	907
Fluctuation margin	<25%

*) related to component weight

**) Weight of particular product, see technical product information

Important Remarks:

- 1) This document provides full declaration of all materials present in Infineon products above a threshold of 0,1 % b.w. (1000 ppm).
- 2) Trace concentrations (i.e. < 0,1 % b.w) present in products are marked with an "X" as far as they represent substances-of-concern.
A list of substances-of-concern can be found at <http://www.infineon.com/soc>.
- 3) All statements are based on our present knowledge and are subject to change at any time due to technical requirements and development.

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